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Novel mm-Wave Oscillator Based on an Electromagnetic Bandgap Resonator

Enrico Lia, Indra Ghosh, Stephen M. Hanham, Benjamin Walter, Fuanki Bavedila, Marc Faucher, Andrew P. Gregory, Leif Jensen, Jan Buchholz, Horst Fischer, Ulrich Altmann, and Rüdiger Follmann

Abstract—This paper introduces a novel millimeter-wave oscillator concept based on an electromagnetic bandgap (EBG) resonator (also called a photonic crystal resonator). To realize an ultra-low phase noise MMIC oscillator, an EBG resonator is developed by introducing a periodic structure into an ultra-high resistivity silicon wafer to create an electromagnetic bandgap which confines a localized resonant mode with a reduced mode dielectric filling factor of 47%. The measured results of the resonator demonstrate an unloaded Q-factor of 108,300 can be achieved at 45 GHz. Measured oscillator phase noise levels of -91.5 , -121.5 and -133 dBc/Hz are obtained at offset frequencies of 1, 10 and 100 kHz, respectively.

Index Terms— dielectric materials, dielectric resonator, microwave oscillators, MMICs, photonic crystals.

I. INTRODUCTION

Nowadays, reference oscillators based on quartz resonators are limited in frequency of operation to a few hundred megahertz. Deriving gigahertz range signals from such a reference requires frequency multiplication or frequency synthesis. However, the multiplication process increases the phase noise of the output signal according to $20\log_{10}$ of the multiplication factor, as well as increasing the complexity of the circuit. In this sense, it is advantageous to have a LO signal generated directly at the fundamental frequency in the millimeter (mm-) wave band. This requires, however, a high quality (Q-) factor resonator operating preferably at several gigahertz. Traditional passive resonators employing metal cavities have their Q-factor limited by the resistive losses in the metal. Alternatively, oscillators operating directly at the fundamental frequency based on ceramic resonators offer average phase noise and are normally not available above 25 GHz.

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Dielectric resonators made of low dielectric loss and high resistivity materials are an interesting alternative to overcoming the problem of limited resonator Q-factors in the mm-wave band. One approach is to fabricate the dielectric resonator from an ultra-high resistivity silicon wafer [1]. An emerging type of mm-wave dielectric resonator that can be implemented using a silicon wafer is an electromagnetic bandgap (EBG) resonator, also known as a photonic crystal resonator [2, 3]. Such a resonator is realized by engineering an EBG in the silicon wafer through the introduction of periodic holes in order to confine a localized resonant mode. A resonator designed in this manner may have a Q-factor limited only by material loss. This material loss may be reduced by designing the resonator in such a way as to concentrate most of the energy outside the silicon and in air. This approach allows the realization of extremely high Q-factors which is a key aspect to achieving very low phase noise in oscillator applications.

Research papers and laboratory demonstrations [4, 5] have shown that dielectric resonators made from low-loss materials such as high resistivity silicon may become an interesting alternative to conventional room-temperature passive mm-wave resonators used in reference and high frequency oscillators, and important components for future mm-wave applications.

This work aims to demonstrate that low-loss ultra-high resistivity silicon resonators can be utilized for high frequency oscillators with significant advantages in obtaining high Q-factor and therefore low phase noise compared to multiplied quartz crystal and traditional high frequency oscillators. In this paper, the novel experiment of using a silicon EBG resonator exhibiting a reduced dielectric filling factor of its resonant mode in an oscillator operating at 45 GHz is demonstrated successfully, establishing a route towards overcoming the

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problem of excessive phase noise affecting high frequency oscillators operating in the mm-wave band.

II. ULTRA-HIGH Q-FACTOR RESONATOR DESIGN

Low-loss and high-performance dielectric materials are crucial for realizing dielectric resonators as part of oscillators in high performance telecommunication systems. The dielectric material chosen for the investigation and characterization of the resonator is the High Resistivity Silicon for GHz and THz Applications supplied by TopSil GlobalWafers A/S [4].

The design of the silicon EBG resonator relies upon the creation of a surrounding region of the silicon exhibiting an EBG and this is realized using a triangular lattice of air holes perforating the planar silicon wafer. The resulting transverse electric (TE)-like bandgap is defined according to the substrate parameters (e.g., its height as well as the hole diameter and the lattice constant). The neutron-irradiated high-resistivity silicon (HRS) used has a measured permittivity ϵ_r equal to 11.68 and loss tangent δ_{loss} of 1.2×10^{-5} (294 K), including both dielectric and finite conductivity losses. The substrate has a thickness of 1000 μm , the holes have a radius of 863.5 μm and a lattice constant of 1831 μm . The periodic EBG structure prohibits propagating modes within its bandgap and the energy stored inside a localized mode cannot be transported through this region of the silicon wafer.

The resonator is formed by the concatenation of unit cells with a small increase in horizontal width period from the central unit cell to the outer unit cells, as shown in Fig. 1, to confine the resonant mode. The unit cell analysis is performed assuming infinite periodicity in the x -axis directions. The unit cells are engineered so that the majority of the propagating mode's energy is concentrated in an air gap rather than the silicon. The approach introduced here employs the idea of reducing the dielectric filling factor of the resonator to reduce overall dielectric loss of the resonator. The filling factor κ is defined as the ratio of the electromagnetic energy of a resonator stored inside the silicon to the total stored electromagnetic energy. By lowering κ the achievable quality factor increases according to $1/(\kappa \tan \delta)$ with $\tan \delta$ being the loss tangent of the silicon substrate material.

The filling factor can be expressed as follows:

$$\kappa = \frac{\iiint_{V_{si}} \epsilon_{si} |E|^2 dv}{\iiint_{V_t} \epsilon(v) |E|^2 dv}, \quad (1)$$

where V_{si} is the volume of the silicon forming the EBG resonator and V_t is the total volume containing the resonant mode. The denominator represents the total energy of the mode. To minimize out-of-plane losses, it is necessary to shape the electric and magnetic field in the resonator to reduce wave-vector components inside the light cone [6, 7]. A common approach is to create a Gaussian envelope of the field by linearly increasing reflection from the center to outer unit cells. This is achieved by varying the horizontal period (width) of the unit cells quadratically with the distance in the $\pm x$ -directions, as shown Fig. 1.

The EBG resonator design has been simulated using a range of tools implementing different techniques such as Meep with FDTD (time-domain) and rectangular grid meshing, CST Studio with FEM and tetrahedral meshing, and Empire XPU

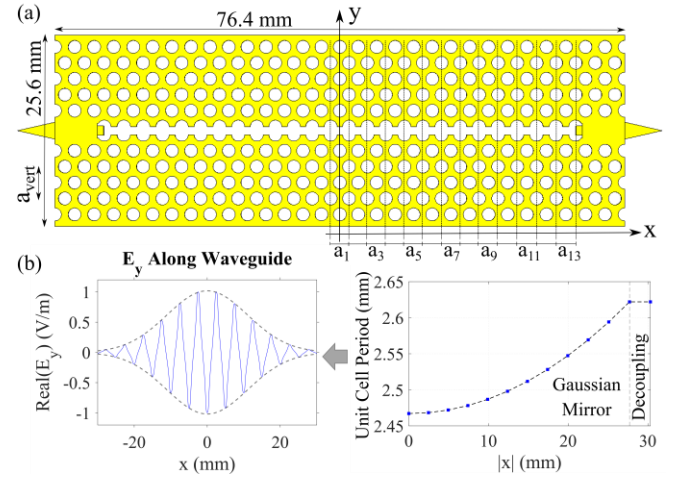


Fig. 1. (a) The EBG resonator with its dimensions and variable periodicity (a_n) along the x -axis. (b) The Gaussian envelope of the resonant mode achieved by linearly increasing the reflection from the center to the outer unit cells.

tool. After careful optimization of the parameters and best simulation results obtained, the EBG resonator was manufactured. An NTD float zone silicon wafer with high resistivity ($>400,000 \Omega\cdot\text{cm}$), 150 mm diameter and 1000 μm thickness is etched using the deep reactive-ion etching (DRIE) method, which is a highly anisotropic process to achieve deep etch depths with steep-sided holes and trenches in wafer substrates.

The measurement results of the full two-port S-parameters achieved an outstanding loaded Q-factor (Q_L) of 52,400 with insertion loss peak ($S_{8,7}$) of -5.75 dB, shown in Fig. 2. The unloaded Q-factor (Q_u) is calculated to be 108,300 at 45.77 GHz using $Q_u = Q_L / (1 - |S_{8,7}(f_0)|)$, where Q_L is calculated from the forward transmission $S_{8,7}$ using the 3 dB method and f_0 is the resonant frequency. It is important to highlight the importance of obtaining an insertion loss of approximately -6 dB to achieve the best phase noise results in oscillator applications [8, 9].

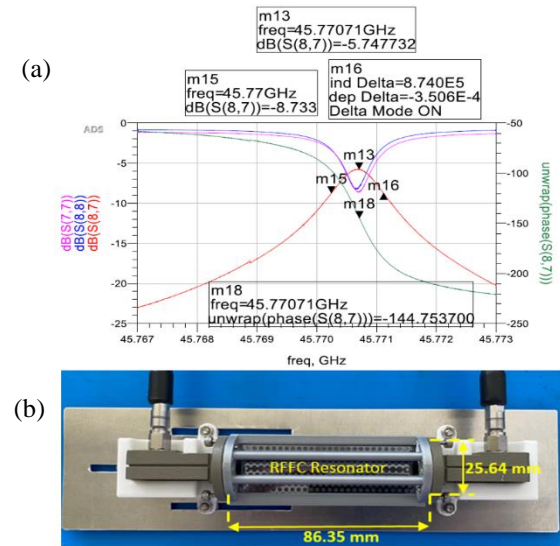


Fig. 2. (a) The measured results of the two-port S-parameters (amplitude and unwrapped phase of the forward transmission $S_{8,7}$, and input reflection $S_{7,7}$ and $S_{8,8}$ amplitudes) coefficients and (b) the EBG resonator in its test jig interfaced with the waveguide-to-coaxial adapters.

III. VCO MMIC DESIGN

The design approach of the active circuit is based on a monolithic microwave integrated circuit (MMIC) voltage-controlled oscillator (VCO) using a high-performance 130 nm SiGe BiCMOS semiconductor technology process from IHP Microelectronics with cutoff frequency F_T up to 250 GHz and maximum frequency $F_{\max} = 340$ GHz. The oscillator has been realized in feedback topology: the MMIC contains a two-stage loop amplifier (black and red regions in Fig. 3) whose 2nd stage has been designed in a balanced configuration, a 10 dB coupler (yellow) which serves to supply the oscillator signal to the output. This is followed by an electronic phase shifter realized by a 90° hybrid coupler (blue) which is terminated by varactor diodes at two ports. The total gain realized within the oscillator loop is 12.5 dB. To couple to the TE_{10} mode in the feed waveguides, the input and output of the circuit are connected through bond-wires to waveguide (WR-19) to microstrip transition probes. The waveguides include a waveguide band-pass filter and fine and coarse phase-shifters, and connect to the EBG resonator through triangular tapers created on the edge of the silicon substrate which protrude inside a standard WR-19 waveguide to couple to the TE_{10} mode. The output of the RF signal is obtained after an output amplifier (green region in Fig. 3) with a gain of 7.8 dB connected in the same way to a waveguide to coaxial adapter.

IHP Microelectronics provides an SG13S design kit for the ADS (Advanced Design Systems) simulation tool used in the design of the oscillator.

Figure 4 shows the block diagram for the MMIC oscillator and Fig. 5 shows the assembled oscillator inside its housing. The total power consumption of the oscillator is 215 mW, size is 157 x 88 x 29 mm and the weight is 442 g, including all connectors.

The loss tangent of the silicon has a sharp increase for temperatures higher than 290 K [10]. To avoid this region, a nominal operation temperature for the oscillator of 263 K is chosen as a compromise between increased cooling power requirements and higher Q-factor. Figure 6 shows the measured phase noise levels of -94.6, -120.3 and -142.6 dBc/Hz obtained at offset frequencies of 1, 10 and 100 kHz, respectively, with an output power of -1.2 dBm at a nominal impedance of 50 Ω at 263 K with zero tuning voltage. The oscillator also works at room temperature (290 K) with a corresponding degradation of 2 - 6 dB in terms of single sideband (SSB) phase noise.

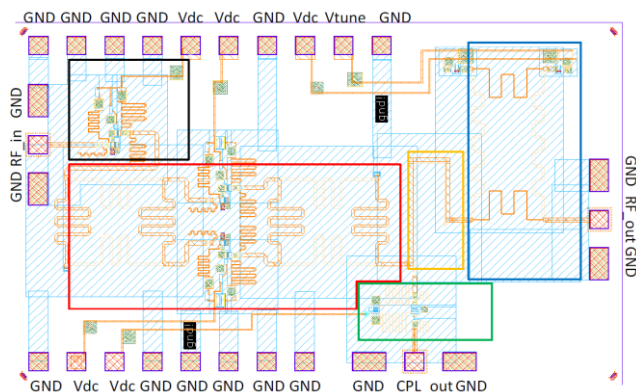


Fig. 3. Layout of the MMIC VCO circuit.

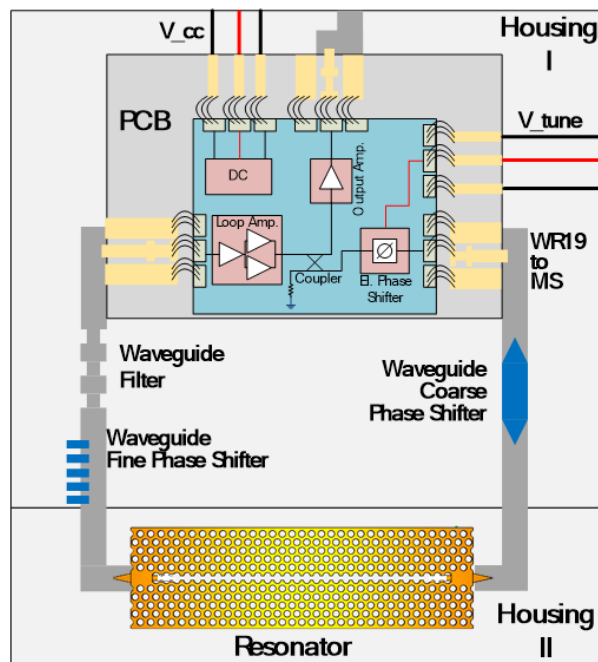


Fig. 4. The complete block diagram of the MMIC VCO.

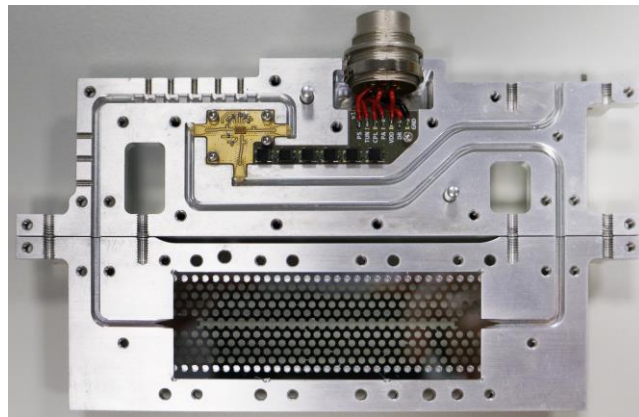


Fig. 5. The final MMIC VCO assembly in its housing (top half removed).

Owing to the temperature variation of the silicon permittivity and the reduced dielectric filling factor of the resonator of 47%, the temperature drift of the oscillator frequency is 1 MHz/K. By means of PID temperature-control and thermally isolating the oscillator from the environment it is expected that a temperature stability of $< \pm 0.05$ K can be achieved resulting in a remaining frequency variation of ± 50 kHz. The electrical tuning range of the oscillator is 239 kHz (0 to 3 Volts), which is limited by the operation of the phase shifters within the narrow passband of the resonator. Further precise frequency adjustment can be carried out by means of the tuning voltage or varying the resonator temperature.

Table 1 compares the overall performance of the oscillator with other microwave and mm-wave oscillators described in the literature. It can be seen that the oscillator compares favourably in terms of phase noise and FOM performance with state-of-the-art oscillators. The oscillator FOM is defined as $FOM = L(\Delta f) - 20 \log(f_0/\Delta f) + 10 \log(P_{DC}/1\text{mW})$, where $L(\Delta f)$ is the phase noise in dBc/Hz at the frequency offset Δf from the oscillator frequency f_0 , and P_{DC} is the total power consumption.

Table 1. Comparison of state-of-the-art microwave and mm-wave oscillators. All SSB phase noise values were normalised to a 45 GHz carrier frequency and estimated values, shown in grey, were estimated based on the intercept within the slope regions.

Ref.	Description	Pout [dBm]	SSB PN [dBc/Hz] @ offset	FOM [dBc/Hz]
[11]	Tunable DRO @ 12.8 GHz	+17.0	-33 @ [100 Hz] -65 @ [1 KHz] -96 @ [10 KHz] -122 @ [100 KHz] -141 @ [1 MHz] -150 @ [10 MHz]	156
[12]	0.18 μ m CMOS Quadrature VCO (20 GHz)	-6.8	-5 @ [100 Hz] -12 @ [1 KHz] -42 @ [10 KHz] -72 @ [100 KHz] -105 @ [1 MHz] -114 @ [10 MHz]	181.5
[13]	Quad. SiGe HBT MMIC VCO (38.5 GHz)	-7.5	-11 @ [100 Hz] -41 @ [1 KHz] -49 @ [10 KHz] -61 @ [100 KHz] -73 @ [1 MHz] -84 @ [10 MHz]	151
[14]	WGM-based Optoelectronic Oscillator (11 GHz)	-15.0	-19 @ [100 Hz] -51 @ [1 KHz] -79 @ [10 KHz] -106 @ [100 KHz] -135 @ [1 MHz] -143 @ [10 MHz]	-
This work	EBG Oscillator (45.8 GHz)	-1.7	-57 @ [100 Hz] -95 @ [1 KHz] -120 @ [10 KHz] -142 @ [100 KHz] -151 @ [1 MHz] -153 @ [10 MHz]	230

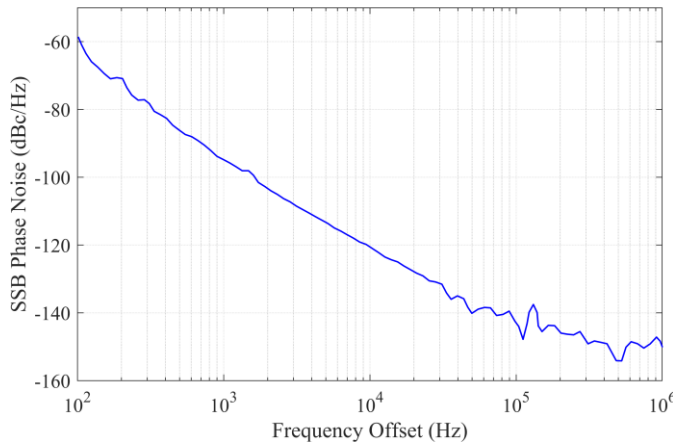


Fig. 6. Measured SSB phase noise of the oscillator at 263 K.

IV. CONCLUSION

This paper demonstrates a novel mm-wave oscillator employing a low-loss high-resistivity silicon resonator with a reduced dielectric filling factor of its resonant mode, leading to an improved Q-factor and thereby addressing the problem of excessive phase noise affecting high frequency oscillators operating in the mm-wave band. The oscillator also benefits from small size and low power consumption. Future work is to increase the Technology Readiness Level (TRL) of the oscillator, improve the frequency stability and tunability, and realize scaled versions operating at higher fundamental mode frequencies.

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